TOSHIBA CCD LINEAR IMAGE SENSOR CCD (Charge Coupled Device)

TCD2503C

The TCD2503C is a high sensitive and low dark current 5000 elements x 3 line CCD color image sensor.

The sensor is designed for color scanner.

The device contains a row of 5000 elements × 3 line photodiodes which provide a 16 lines/mm across a A3 size paper. The device is operated by 5 V pulse, and 12 V power supply.

FEATURES

Number of Image Sensing Element

5000 elements x 3 line

Image Sensing Element Size 14 μ m by 14 μ m on

14 µm centers

: High sensitive pn photodiode Photo Sensing Region

Clock 2 Phase (5 V)

Distance Between Photodiode Array: 84 μ m (6 lines)

Internal Circuit Clamp circuit

Package 24 pin DIP

Color Filter Red, Green, Blue

MAXIMUM RATINGS (Note 1)

f.dzsc.com

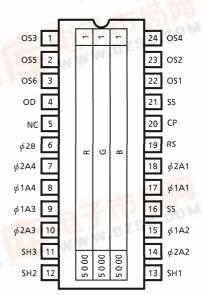
CHARACTERISTIC	SYMBOL	RATING	UNIT
Clock Pulse Voltage	Vφ		
Shift Pulse Voltage	V _{SH}	-0.3~8	V
R <mark>eset Pulse Voltag</mark> e	V _{RS}	-0.3~6	\ \
Clamp Pulse Voltage	VCP		
Power Supply Voltage	V _{OD}	-0.3~15	V
Operating Temperature	T _{opr}	0~60	°C
Storage Temperature	T _{stg}	- 25∼85	°C

All voltage are with respect to SS terminals (Note 1) (Ground).



Weight: 17.1 g (Typ.)

PIN CONNECTIONS



(TOP VIEW)

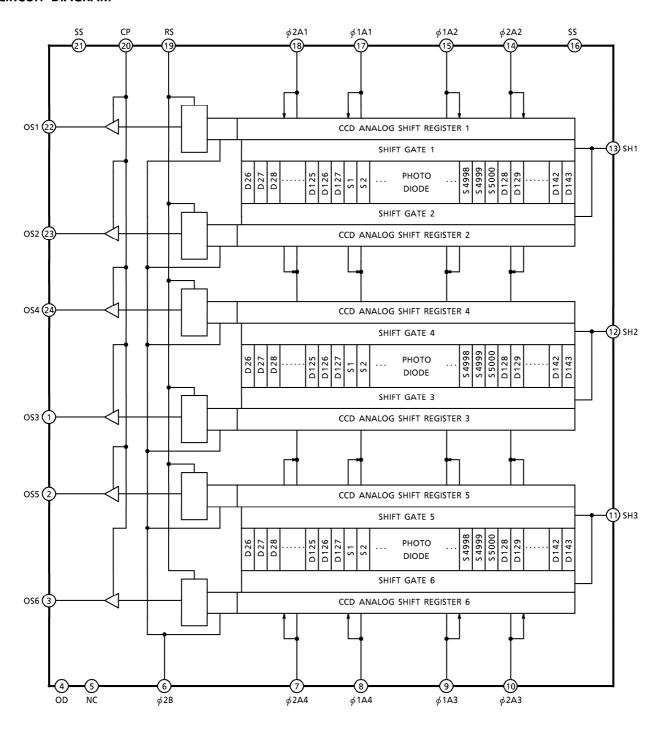
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CIRCUIT DIAGRAM



PIN NAMES

PIN No.	SYMBOL	NAME	PIN No.	SYMBOL	NAME
1	OS3	Signal Output 3 (Green)	13	SH1	Shift Gate 1
2	OS5	Signal Output 5 (Red)	14	φ2A2	Clock 2 (Phase 2)
3	OS6	Signal Output 6 (Red)	15	φ1A2	Clock 2 (Phase 1)
4	OD	Power (Analog)	16	SS	Ground
5	NC	Non Connection	17	φ1A1	Clock 1 (Phase 1)
6	φ2B	Final Stage clock (phase 2)	18	φ2A1	Clock 1 (Phase 2)
7	φ2A4	Clock 4 (Phase 2)	19	RS	Reset Gate
8	φ1 A4	Clock 4 (Phase 1)	20	СР	Clamp Gate
9	φ1A3	Clock 3 (Phase 1)	21	SS	Ground
10	φ2A3	Clock 3 (Phase 2)	22	OS1	Signal Output 1 (Blue)
11	SH3	Shift Gate 3	23	OS2	Signal Output 2 (Blue)
12	SH2	Shift Gate 2	24	OS4	Signal Output 4 (Green)

OPTICAL / ELECTRICAL CHARACTERISTICS

(Ta = 25°C, V_{OD} = 11 V, V $_{\phi}$ = V_{SH} = V_{RS} = V_{CP} = 5 V (PULSE), f $_{\phi}$ = 1 MHz LOAD RESISTANCE = 100 k $_{\Omega}$, t_{INT} (INTEGRATION TIME) = 10 ms, LIGHT SOURCE = A LIGHT SOURCE + CM500S FILTER (t = 1.0 mm))

CHARACTERISTIC		SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
	Red	R _R	12.1	17.3	22.5		
Responsivity	Green	RG	15.1	21.7	28.3	V / Ix·s (N	(Note 2)
	Blue	R _B	5.0	7.2	9.4		
Photo Response Non Uniformity		PRNU (1)	_	10	20	%	(Note 3)
		PRNU (3)	_	3	12	mV	(Note 4)
Saturation Output Voltage		VSAT	2.0	_	_	V	(Note 5)
Saturation Exposure		SE	_	0.18	_	lx∙s	(Note 6)
Dark Signal Voltage		V _{DRK}	_	1	5	mV	(Note 7)
Dark Signal Non Uniformity		DSNU	_	2	10	mV	(Note 8)
DC Power Dissipation		PD	_	800	1200	mW	
Total Transfer Efficiency		TTE	92	_	_	%	
Output Impedance		Z _o	_	0.2	0.5	kΩ	
DC Signal Output Voltage		Vos	4.5	6.0	7.5	V	(Note 9)
Random Noise		Ν _D σ	_	1.3	_	mV	(Note 10)

- (Note 2) : Sensivity is defined for each color of signal outputs average when the photosensitive surface is applied with the light of uniform illumination and uniform color temperature.
- (Note 3): PRNU (1) is defined for each color on a single chip by the expressions below when the photosensitive surface is applied with the light of uniform illumination and uniform color temperature.

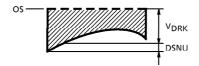
PRNU (1) =
$$\frac{\Delta \chi}{\chi} \times 100$$
 (%)

Where $\overline{\chi}$ is average of total signal output and $\Delta \chi$ is the maximum deviation from $\overline{\chi}$.

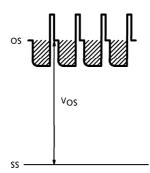
- (Note 4) : PRNU (3) is defined as maximum voltage with next pixel, where measured 5% of SE (Typ.).
- (Note 5): VSAT is defined as minimum Saturation Output voltage of all effective pixels.
- (Note 6) : Definition of SE

$$SE = \frac{V_{SAT}}{R_{G}}$$

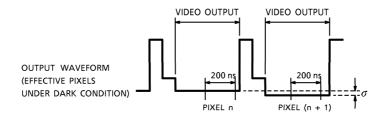
- (Note 7): VDRK is defined as average dark signal voltage of all effective pixels.
- (Note 8) : DSNU is defined as different voltage between V_{DRK} and V_{MDK} , when V_{MDK} is maximum dark signal voltage.



(Note 9) : DC Signal Output Voltage is defined as follows:



(Note 10): Random noise is defined as the standard deviation (sigma) of the output level difference between two adjacent effective pixels under no illumination (i.e. dark conditions) calculated by the following procedure.



- 1) Two adjacent pixels (pixel n and n + 1) in one reading are fixed as measurement points.
- 2) Each of the output levels at video output periods averaged over 200 ns period to get Vn and V(n + 1).
- 3) V(n + 1) is subtracted from Vn to get ΔV .

$$\Delta V = Vn - V(n + 1)$$

4) The standard deviation of ΔV is calculated after procedure 2) and 3) are repeated 30 times (30 readings).

$$\overline{\Delta V} = \frac{1}{30} \frac{30}{i} \sum_{i=1}^{30} |\Delta Vi| \qquad \sigma = \sqrt{\frac{1}{30} \frac{30}{i} \sum_{i=1}^{30} (|\Delta Vi| - \overline{\Delta V})^2}$$

5) Procedure 2), 3) and 4) are repeated 10 times to get 10 sigma value.

$$\overline{\sigma} = \frac{1}{10} \sum_{j=1}^{10} \sigma_j$$

6) $\overline{\sigma}$ value calculated using the above procedure is observed $\sqrt{2}$ times larger than that measured relative to the ground level. So we specify random noise as follows.

Random noise =
$$\frac{1}{\sqrt{2}} \overline{\sigma}$$

OPERATING CONDITION

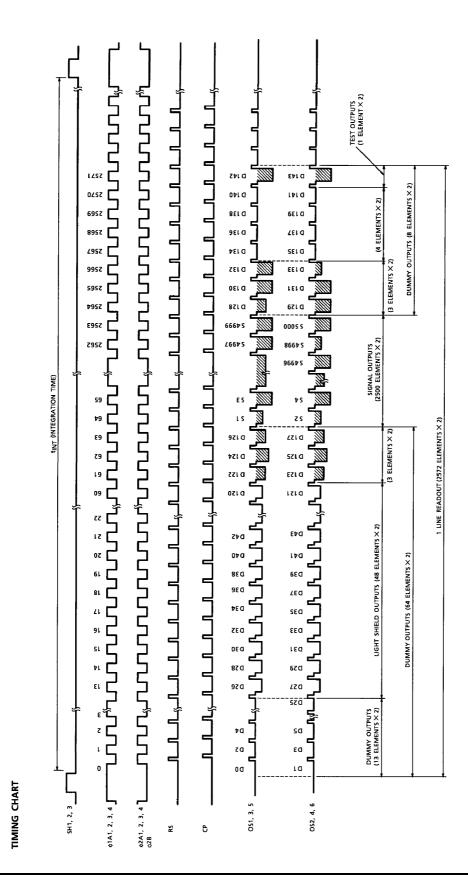
CHARACTERISTIC		SYMBOL	MIN.	TYP.	MAX.	UNIT	
Clask Bulsa Valtana	"H" Level	\/ / A	4.5	5.0	5.5	V	
Clock Pulse Voltage	"L" Level	V _Ø A	0	_	0.5	V	
Final Stage Clark Bulse Valtage	"H" Level	V//D	4.5	5.0	5.5	V	
Final Stage Clock Pulse Voltage	"L" Level	VøB	0	_	0.5		
Shift Pulse Voltage (Note 11)	"H" Level	V _{SH}	V <i></i> ∕ A"H" − 0.5	Vφ Α" Η"	Vφ Α" Η"	V	
	"L" Level		0	_	0.5		
Boset Bulsa Voltage	"H" Level	\/	4.5	5.0	5.5	V	
Reset Pulse Voltage	"L" Level	V _{RS}	0	_	0.5	'	
Clamp Pulse Voltage	"H" Level	V	4.5	5.0	5.5	V	
	"L" Level	V _{CP}	0	_	0.5	V	
Power Supply Voltage		V_{OD}	10.5	11.0	13.0	V	

(Note 11) : $V_{\phi}A''H''$ means the high level voltage of $V_{\phi}A$ when SH pulse is high level.

CLOCK CHARACTERISTICS (Ta = 25°C)

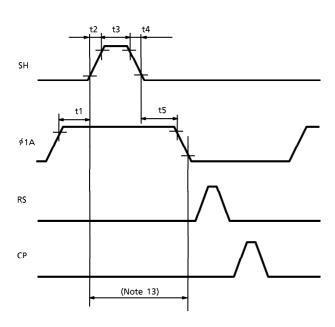
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Clock Pulse Frequency	fφ	_	1	13	MHz
Reset Pulse Frequency	f _{RS}	_	1	13	MHz
Clamp Pulse Frequency	f _{CP}	_	1	13	MHz
Clock Capacitance (Note 12)	C _Ø A	_	250	_	pF
Final Stage Clock Capacitance	C∳2B	_	50	_	pF
Reset Gate Capacitance	C _{RS}	_	50	_	pF
Shift Gate Capacitance	C _{SH}	_	50	_	pF
Clamp Gate Capacitance	C _{CP}	_	50	_	pF

(Note 12) : $V_{OD} = 12 V$



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TIMING REQUIREMENTS



#8 t9 t10

RS

t14

t15

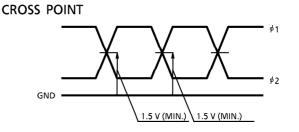
CP

t11

t12

t21

(Note 13): Each RS and CP pins put to Low level during this period.

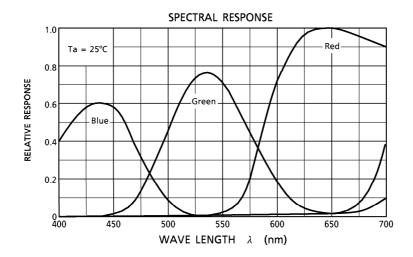


CHARACTERISTIC	SYMBOL	MIN.	TYP. (Note 14)	MAX.	UNIT
Dulco Timing of SH and /1A	t1	0	1000	_	nc
Pulse Timing of SH and ϕ 1A	t5	500	1000	_	ns
SH Pulse Rise Time, Fall Time	t2, t4	0	50	_	ns
SH Pulse Width	t3	1000	2000	_	ns
ϕ 1, ϕ 2 Pulse Rise Time, Fall Time	t6, t7	0	50	_	ns
RS Pulse Rise Time, Fall Time	t8, t10	0	20	_	ns
RS Pulse Width	t9	10	100	_	ns
CP Pulse Rise Time, Fall Time	t11, t13	0	20	_	ns
CP Pulse Width	t12	10	100	_	ns
Pulse Timing of ϕ 2B and CP	t14	5	40	_	ns
Dules Timing of DC and CD	t15	0	100	_	
Pulse Timing of RS and CP	t16	10	100	_	ns
Video Data Delay Time (Note 15)	t21	_	15	_	ns

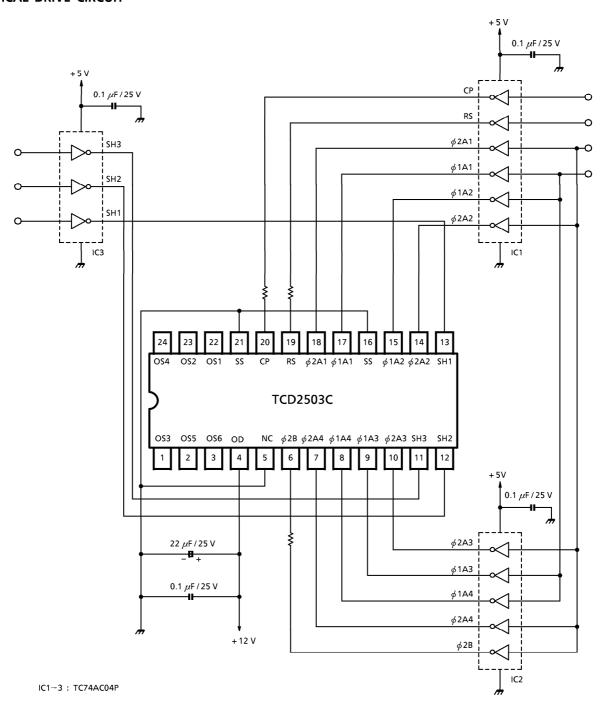
(Note 14) : TYP. is the case of fRS = 1 MHz. (Note 15) : Load Resistance is 100 k Ω .

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TYPICAL PERFORMANCE CURVES



TYPICAL DRIVE CIRCUIT



PRECAUTIONS FOR USE OF CCD IMAGE SENSOR

1. Static Electricity

This device has some weakly terminals for static electricity. Therefor, please pay attention to treat this device.

CCD Image Sensor is protected against static electricity, but inferior puncture mode device due to static electricity is sometimes detected. In handling the device, it is necessary to execute the following static electricity preventive measures, in order to prevent the trouble rate increase of the manufacturing system due to static electricity.

- a. Prevent the generation of static electricity due to friction by making the work with bare hands or by putting on cotton gloves and non-charging working clothes.
- b. Discharge the static electricity by providing earth plate or earth wire on the floor, door or stand of the work room.
- c. Ground the tools such as soldering iron, radio cutting plier or pincette.
 It is not necessarily required to execute all precaution items for static electricity.
 It is all right to mitigate the precautions by confirming that the trouble rate within the prescribed range.

2. Window Glass

As the dust and station on the glass window of the package will cause black flow on the picture, never fail to clean the glass surface before using. (Blow compressed vapor, and wipe off the dust, and dirt with soft cloth or paper slightly moistened with alcohol).

Fully take care for the handling of the device as the window glass will break or a strong friction is given to the window glass surface.

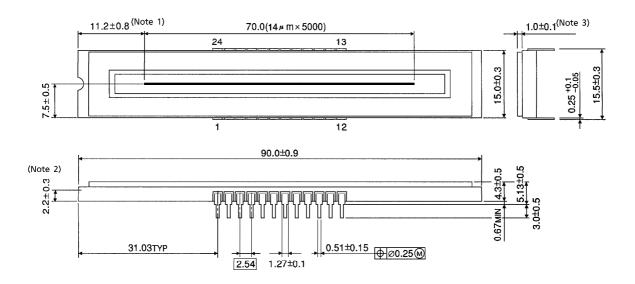
3. Incident Light

CCD image sensor has sensitivity in a wide range zone of light wave length, but its characteristics will sometimes widely change when used with long wave length input light outside the visual light zone.

PACKAGE OUTLINE

WDIP24-C-600-2.54 (D)

Unit in mm



(Note 1) : No. 1 SENSOR ELEMENT (S1) TO EDGE OF PACKAGE.

(Note 2) : TOP OF CHIP TO BOTTOM OF PACKAGE.

(Note 3) : GLASS THICKNES (n = 1.5)

Weight: 17.1 g (Typ.)